



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Lamson et al. ✓
Serial No.: 09/989,263 ✓
Filed: 11/19/01 ✓
For: **LOW CAPACITANCE COUPLING WIRE BONDED SEMICONDUCTOR
DEVICE**

Art Unit: 2823
Examiner: Maldonado, J.
Docket: TI-31189

#3
Election
J. Maldonado
7/26/02

ELECTION

July 9, 2002

Commissioner of Patents
and Trademarks
Washington, D.C. 20231

MAILING CERTIFICATE UNDER 37 C.F.R. 1.8 (A)

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231 on July 9, 2002.

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Ginger Cox

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Sir:

Responsive to the Office Action dated June 18, 2002, please enter the following:

For prosecution, Applicants elect Group I, Claims 1-16, drawn to a semiconductor device, classified in class 257, subclass 687.

Applicants acknowledge that Claim 17 is withdrawn from further examination.

A prompt action on the merits is respectfully requested.

Respectfully Submitted,

Gary C. Honeycutt
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Attorney for Applicant

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July 9, 2002

VIA FIRST CLASS MAIL

Commissioner of Patents
and Trademarks
Washington, D.C. 20231

Re: Patent Application for:
**"LOW CAPACITANCE COUPLING WIRE BONDED
SEMICONDUCTOR DEVICE"**
Serial No.: 09/989,263
Attorney Docket: TI-31189
Our File: 50000.2163

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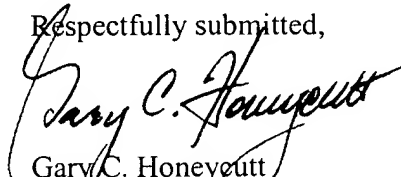
Dear Sir:

Enclosed for filing please find the following items relating to the above-identified application:

- (1) Election Document; and
- (2) Postcards.

Please file the above documents and return the date-stamped postcards to the corresponding addresses, as indicated. In the meantime, if you have any questions or comments concerning this matter, please call the undersigned. Otherwise, please accept the enclosed.

Respectfully submitted,


Gary C. Honeycutt
Reg. No. 20,250

GCH:glc
Enclosures
cc: James Brady, III (Texas Instruments, w/ encls.)